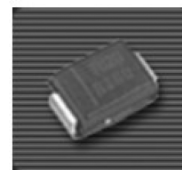
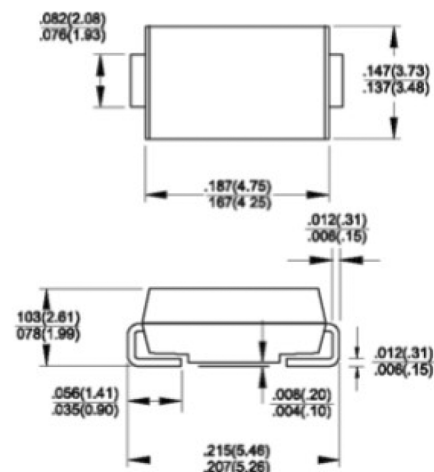


Features

- ◆ Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- ◆ Glass passivated junction
- ◆ Low incremental surge resistance, excellent clamping capability
- ◆ 600W peak pulse power capability with a 10/1000us wave-form, repetition rate(duty cycle):0.01%
- ◆ Very fast response time
- ◆ High temperature soldering guaranteed: 250°C/10 seconds at terminals
- ◆ AEC-Q101 Qualified



DO-214AA (SMB)



Mechanical Data

- ◆ Cases: JEDEC DO-214AA(SMB J-Bend) molded plastic
- ◆ Terminals: Solder plated,solderable per MIL-STD-750, Method 2026
- ◆ Polarity: For uni-directional types the band denotes the cathode, Which is positive with respect to the anode under normal TVS operation
- ◆ Weight:0.003oz., 0.093 gram

Devices for Bidirectional Application

For bi-directional device, use suffix CA(e.g.AP6SMB36CA).

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Peak pulse power dissipation with a 10/1000us waveform ^(1,2)	P _{PPM}	Min.600	W
Peak pulse current with a 10/1000us waveform ⁽¹⁾	I _{PPM}	See Next Table	A
Power dissipation on infinite heatsink, T _A =50°C	P _{M(AV)}	5.0	W
Peak forward surge current, 8.3ms single half sine-wave uni-directional only ⁽²⁾	I _{FSM}	100	A
Typical thermal resistance from junction to ambient ⁽³⁾	R _{THJA}	100	°C/W
Typical thermal resistance from junction to lead	R _{THJL}	20	°C/W
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150	°C

Notes:1.Non-repetitive current pulse, per Fig.3 and derated above T_A=25°C per Fig.2

2. Mounted on 0.2*0.2"(5.0*5.0mm) copper pads to each terminal

3. Mounted on minimum recommended pad layout

Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. $V_F=3.5V$ at $I_F=100A$ (uni-directional only)

Device type	Device marking code		Breakdown voltage $V_{(BR)}$ (Volts) ⁽¹⁾		Test current at I_T (mA)	Stand-off voltage V_{WM} (Volts)	Maximum reverse leakage at V_{WM} I_D ⁽³⁾ (uA)	Maximum peak pulse current I_{PPM} ⁽²⁾ (A)	Maximum clamping voltage at I_{PPM} V_C (Volts)	Maximum temperature coefficient of $V_{(BR)}$ (%/°C)
	UNI	BI	Min.	Max						
AP6SMB36A/CA	A36A	A36C	34.2	37.8	1.0	30.8	1.0	12.0	49.9	0.099

- Notes:
- $V_{(BR)}$ measured after I_T applied for 300us square wave pulse or equivalent
 - Surge current waveform per Fig. 3 and derate per Fig.2
 - For bi-directional types having V_{WM} of 10Volts and less, the I_D limit is doubled.
 - All terms and symbols are consistent with ANSI/IEEE C62.35

Ratings And Characteristic Curves

Fig. 1 – Peak Pulse Power Rating Curve

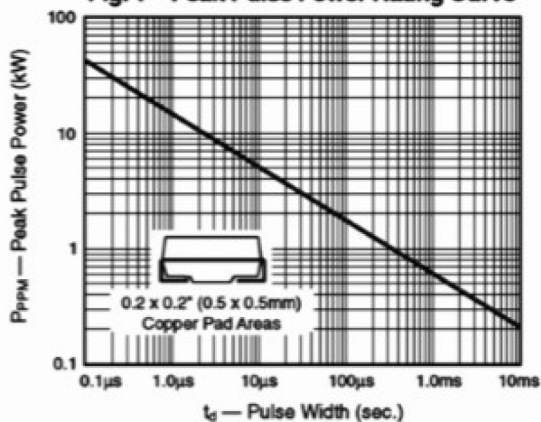


Fig. 2 – Pulse Derating Curve

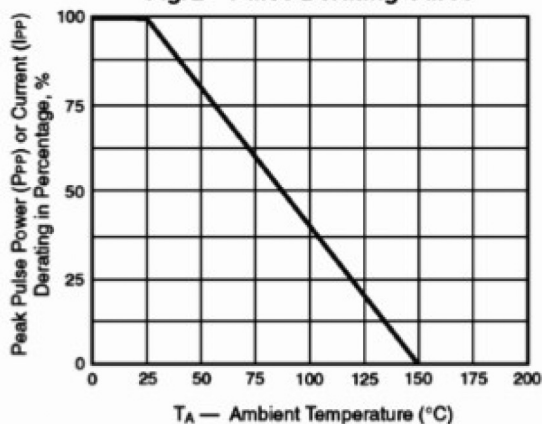


Fig. 3 – Pulse Waveform

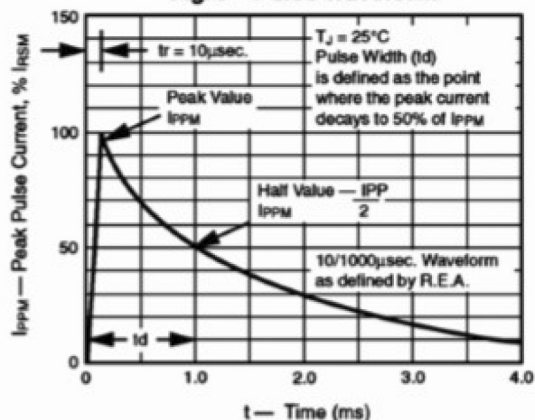


Fig. 4 – Typical Junction Capacitance

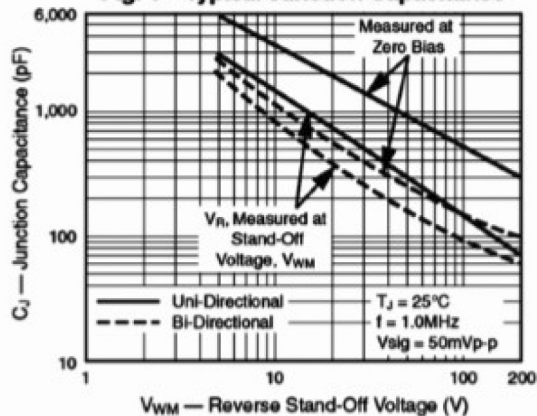


Fig. 5 – Typical Transient Thermal Impedance

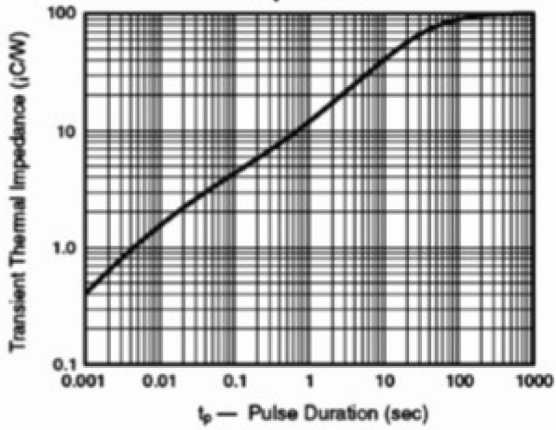


Fig. 6 – Maximum Non-Repetitive Peak Forward Surge Current

